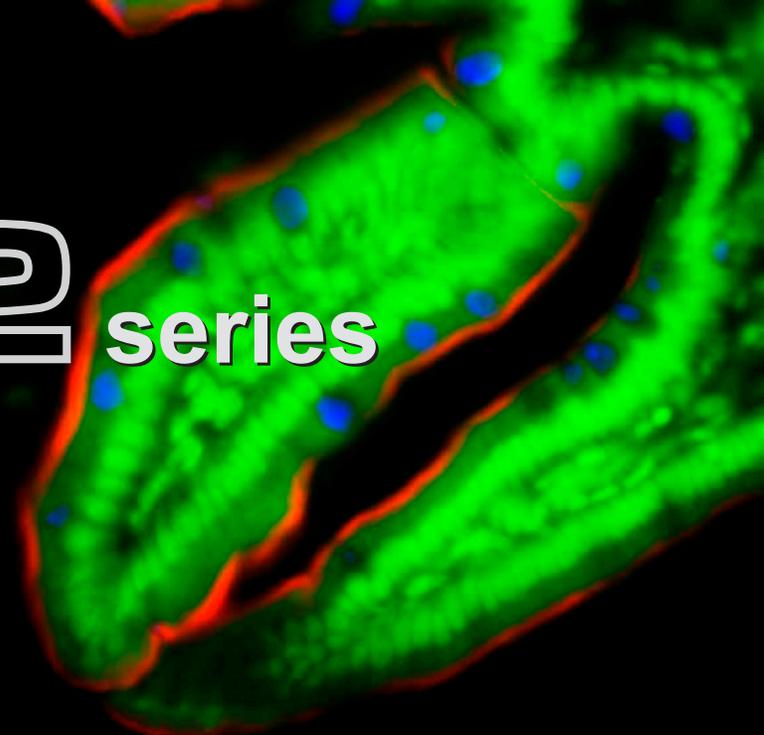


# ImagEM<sup>®</sup>X2 series

EM-CCD camera



## Multiply faster

The ImagEM X2 is an extremely versatile camera that quietly delivers 70 frames/s at full frame and up to 1076 frames/s with analog binning and regions of interest. With very high signal to noise in near dark conditions and extremely low dark current, the ImagEM X2 enables quantitative ultra-low light imaging both for long integration times and at high speed. With EM gain off, the extremely deep full well capacity can extract information from the lowest contrast bright images. Additional features allow for optimized camera triggering, on-board for EM gain protection, streamlined connectivity through IEEE1394b, improved overall signal to noise and increased non-EM dynamic range. Hamamatsu has taken the beloved 512 × 512 EM-CCD sensor and created a masterfully redesigned camera that delivers maximum speed and precision performance. The ImagEM X2-1K 1024 × 1024 version is also available.

High-speed readout (ImagEM X2)

**70** frames/s

at full resolution

**1076** frames/s

at Sub-array 16 pixel, 4×4 binning

High QE

over **90** %

wavelength 500 nm to 650 nm



**HAMAMATSU**  
PHOTON IS OUR BUSINESS

## Hungry for Photons

With large pixels, high QE, and relatively zero readout noise, EM-CCD technology performs in low light conditions. How low light? When you've got fewer than 10 photons per pixel between the sample and background, EM-CCDs are the perfect tool for the job, delivering the best SNR of any camera technology. For high mag, biologically relevant applications with routine exposure times of 10 ms to 30 ms, the sample is likely emitting hundreds to thousands of photons per pixel. But with faster speeds come shorter exposure times, risking the ability to capture more than tens of photons per pixel in one shot and therefore pushing the application into the ultra-low light zone.

The ImagEM X2 series makes these super-fast exposures possible and has the sensitivity to provide visually pleasing and quantitatively meaningful images in a photon-starved environment.

## Features

### Faster readout

By clocking pixel readout at 22 MHz, the ImagEM X2 is able to achieve 70.4 frames/s with full frame resolution. That's more than 2× the original ImagEM and is faster than any commercially available camera using the sensor. The ImagEM X2-1K is able to run 18.5 frames/s with full frame resolution.

ImagEM X2 (Clock: 22 MHz)

Binning	Sub-array (Effective vertical width)					
	512	256	128	64	32	16
1 × 1	70.4	133	241	405	613	820
2 × 2	131	238	400	606	813	981
4 × 4	231	389	588	794	962	1076

(Unit: frames/s)

ImagEM X2-1K (Clock: 22 MHz)

Binning	Sub-array (Effective vertical width)						
	1024	512	256	128	64	32	16
1 × 1	18.5	34.9	62.7	104	156	208	249
2 × 2	34.7	62.5	104	155	207	248	275
4 × 4	61.8	102	154	205	245	272	288

(Unit: frames/s)

### Corner readout

By selectively imaging at the edge of the sensor, closest to the read register of the chip, it is possible to achieve even greater speeds of small ROIs.

ImagEM X2 (Clock: 22 MHz)

Binning	Sub-array					
	512×512	256×256	128×128	64×64	32×32	16×16
1 × 1	70.4	133	285	495	741	893
2 × 2	131	238	456	699	901	981
4 × 4	231	389	645	863	981	1076

(Unit: frames/s)

ImagEM X2-1K (Clock: 22 MHz)

Binning	Sub-array						
	1024×1024	512×512	256×256	128×128	64×64	32×32	16×16
1 × 1	18.5	34.9	79.5	161	237	237	298
2 × 2	34.7	62.5	126	215	274	274	307
4 × 4	61.8	102	179	256	293	293	305

(Unit: frames/s)

### Lower readout noise

In any image sensor, faster readout means increased readout noise. Yet readout noise is considered irrelevant for EM-CCDs because of the EM gain. The ImagEM X2 series even before applying EM gain, has fast speed and low readout noise. But didn't we just say readout noise in EM-CCD was irrelevant? Yes, in SNR equations this is true. However, if the primary purpose of EM gain is to overcome readout noise, then this will be accomplished with less gain in the ImagEM X2 series and less voltage in the EM register, translating into theoretically more stable EM gain calibrations and greater sensor longevity.

Type number			C9100-23B (ImagEM X2 EM-CCD camera)	C9100-24B (ImagEM X2-1K EM-CCD camera)
Readout noise (rms) (typ.)	EM-CCD readout	EM gain	36 electrons (at 22 MHz)	15 electrons (at 22 MHz)
		4× (C9100-23B)	25 electrons (at 11 MHz)	10 electrons (at 11 MHz)
		10× (C9100-24B)	8 electrons (at 0.6875 MHz)	3 electrons (at 0.6875 MHz)
	EM gain 1200×	1 electron max.		
	NORMAL CCD readout		8 electrons (at 0.6875 MHz)	10 electrons (at 0.6875 MHz)

## Mechanical shutter

The ImagEM X2 series includes an integrated mechanical shutter in order to protect the camera from EM gain degradation and to lessen afterimage effects. The mechanical shutter is software controlled.

## EM gain measurement and calibration (Patented)

Gain aging is a known and expected process in EM technology. Even when every care is taken to minimize gain aging, use of the camera in EM mode, especially with high gains or high intensity light, can degrade the gain. Since this is a use-dependent phenomenon, it's important to know when it's happened and to have the ability to easily recalibrate. These two functions in the ImagEM X2 series make this crucial maintenance of the camera software accessible and user friendly.

## IEEE 1394b connectivity

The data rates of the ImagEM X2 series are well suited to the trusted and easy to use IEEE1394b connectivity.

## SMA triggering ports

In its new incarnation, the ImagEM X2 series sports four shiny and compact SMA ports, one for input of an external trigger and three for output to other devices. These ports can be used to access an array of triggering options including three additional features: programmable trigger input/output, trigger delay and trigger ready. There is no denying that EM-CCD technology offers the best SNR for ultra-low light imaging, and the ImagEM X2 offers the fastest speeds combined with multiple engineering enhancements to allow you to make the most of this technology.

## Direct electron display

Output signal can be indicated in "electrons" instead of pixel AD counts in application software.

## Black clip / White clip function

It enables setting an upper or lower threshold of intensity. If there is a brighter or darker location than a sample of interest in an image, this function allows clipping the upper limit or lower limit of intensity to make Auto LUT function work effectively.

## Cooling status output

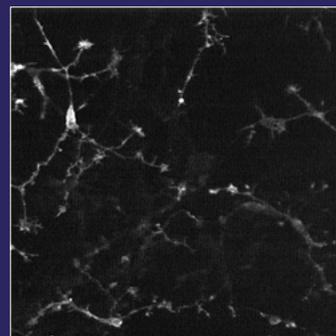
The camera indicates when it has reached the target cooling temperature.

## → Applications

- Protein-protein interaction
- Calcium waves in cell networks and intracellular ion flux
- Real time spinning disk confocal microscopy
- Single molecule imaging with TIRF microscopy
- Fluorescence in-vivo blood cell microscopy
- Gene expression imaging using luminescence

### ■ Image example: Real time confocal imaging

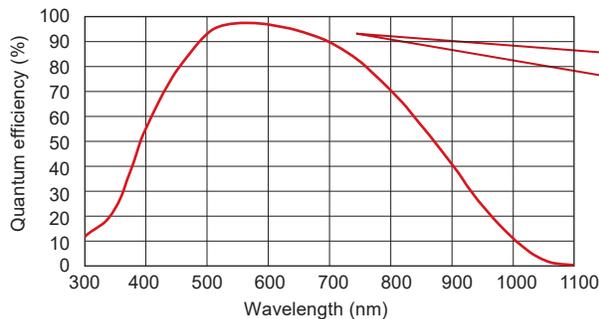
Fast imaging of mouse brain cell with Cy3 imaged with confocal scanner unit



- EM gain: 150x
- Exposure time: 10 ms
- Effective number of pixels: 512x512
- Binning: 1x1
- Objective lens: 40x
- Confocal unit: CSU-W1
- Excitation laser: 561 nm

## High Sensitivity

### High QE



The beloved EM-CCD sensor provides over 90 % peak QE.

### High EM gain of maximum 1200×

EM gain feature is ideal for live cell imaging because of shorter exposure times and reduced excitation light levels.

- Comparison of sensitivity with conventional camera: Luminescence imaging of HeLa cells expressing Renilla Luciferase.

Conventional cooled CCD camera

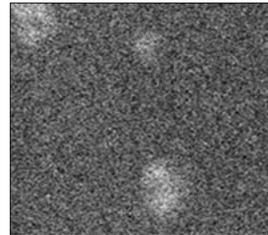
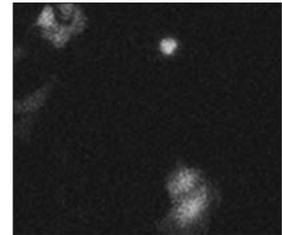


ImagEM X2



## Low Noise

### Minimal dark noise is another benefit of stable cooling performance

The dark current of a CCD depends on the temperature, and it decreases by half when the temperature drops by approximately 7 °C to 8 °C. Therefore, cooling a CCD is a very good way to reduce dark current noise.

The ImagEM X2 series's stable cooling enables stable output and its water cooling minimizes dark current.

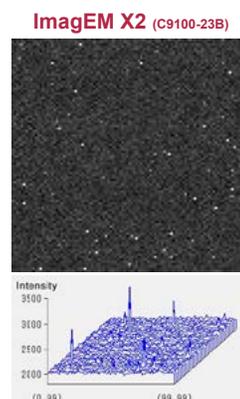
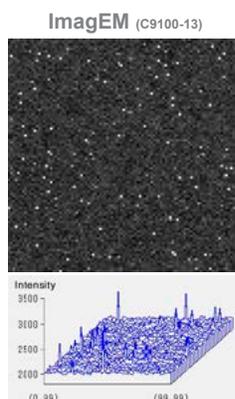
### Highly stabilized control of sensor temperature with either water or forced-air cooling

Water or forced-air cooling is selectable for any application, and optimal cooling temperature can be set in each cooling mode.

### Optimized sensor drive methods significantly reduce the clock induced charge (CIC)

Dark current consists of thermal charge and clock induced charge (CIC). CIC will dominate the dark charge in the images taken at short exposure time, and thermal charge will dominate the dark charge in images taken at longer exposures. The camera is adjusted to use the optimized drive method suitable to the scan speed. The biologist doesn't have to think about CIC optimization for long or short exposures. The camera handles it automatically.

- Comparison of noise: Comparison of two clock induced charge images



#### Intensity profile

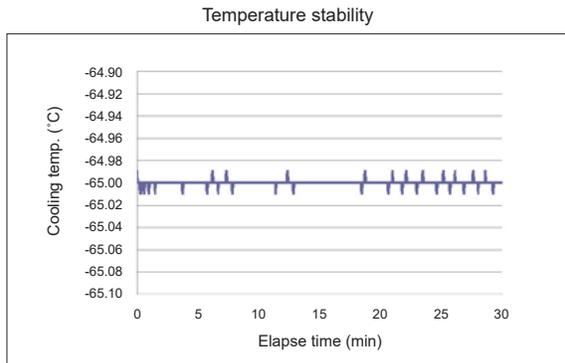
(EM gain: 1200x, Exposure time: 30 ms, no light, enlarged 100 x 100 pixel region)

# Great Stability

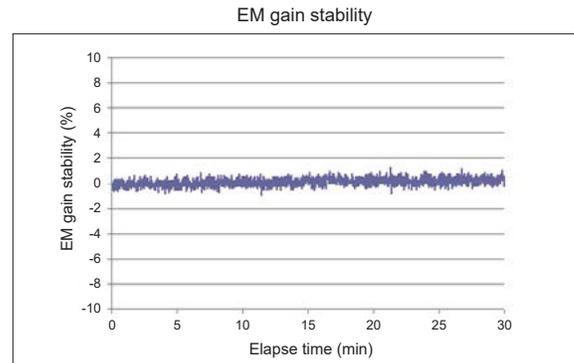
## Highly stabilized EM gain by cooling temperature control

Maintaining stable cooling temperature is essential to stable gain settings required for superior performance in long duration imaging and analysis. Very precise control of the cooling temperature in the ImagEM X2 series is a key benefit.

### Examples of temperature stability and EM gain stability



- Temperature stability: 0.01 °C
- Camera: C9100-23B
- Clock: 22 MHz
- Cooling temperature: -65 °C
- Air cool, Ambient temperature: +20 °C
- After warming up, start measurement.

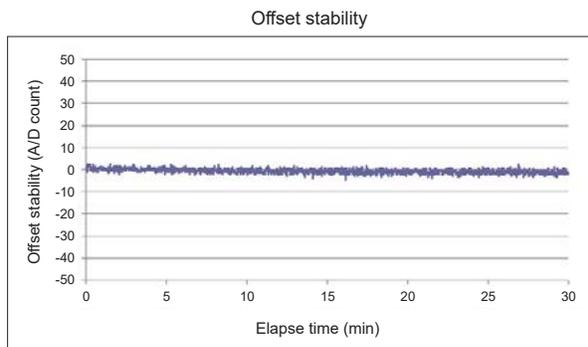


- EM gain stability: 1 %
- Camera: C9100-23B
- Clock: 22 MHz
- Cooling temperature: -65 °C
- Air cool, Ambient temperature: +20 °C
- After warming up, start measurement.

## Stability of mean bias value (Digitizer offset)

The baseline is constant over time providing signal stability for long term measurements.

### Example of baseline variance



- Camera: C9100-23B
- Cooling method: Air cooled
- Clock: 22 MHz
- EM gain: 4x
- Exposure time: 13.93 ms
- No light
- After warming up, start measurement.

## EM gain protection

It is important to operate the camera in ways that minimize the rate of gain aging and extend the life of the camera. The ImagEM X2 protects EM gain in two levels: EM gain warning and EM gain protection. EM gain protection mode stops charge transfer through the EM gain register when excessive output conditions have occurred which may damage the sensor.

## EM gain readjustment \*

Over time all EM-CCD cameras exhibit gain degradation. The EM gain can be readjusted by raising the voltage in the multiplying register. The EM gain readjustment can be done by software which comes with the camera. However, the number of times the EM gain can be readjusted is limited.

\*This feature is available when the camera is operated with DCAM-API. (DCAM-API is a software driver which supports HAMAMATSU digital cameras.)

## Selectable Readout Modes

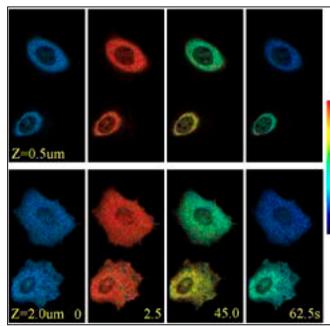
Select a readout mode for optimal image acquisition based on the sample brightness or desired frame rate or exposure time.

### EM-CCD readout

For short exposure, high sensitivity imaging

#### ■ Sample of EM-CCD readout

Confocal calcium ion imaging of HeLa cells expressing yellow Chameleon 3.6. This image shows changes of histamine stimulated calcium ion with two Z positions and four time lapse.



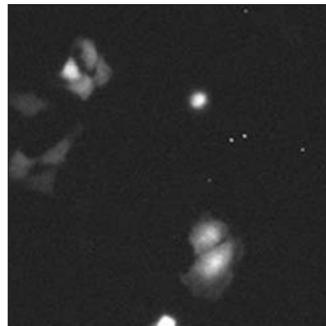
- Objective lens: 100×
- EM gain: 300×
- Exposure time: 100 ms
- Confocal unit: CSU by Yokogawa Electric Co.
- CFP/YFP FRET: 2 wavelength imaging, W-view optics A8509
- Z scan: 19 slices / 2.5 s Piezoelectric Z stage
- Data courtesy of:
  - Dr. Kenji Nagai, Dr. Kenta Saito Hokkaido Univ. Nikon imaging center

### Normal-CCD readout

For high dynamic range imaging

#### ■ Sample of Normal-CCD readout

Luminescence imaging of HeLa cells expressing Renilla Luciferase.



- Objective lens: UApo/340 20×
- Exposure time: 5 minutes
- Cooling method: Water cooled (-80 °C)
- Binning: 2×2

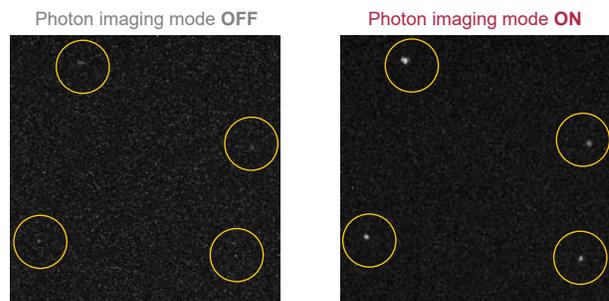
An often overlooked benefit of EM-CCD technology is the ability to utilize the camera as a standard CCD. In non-EM mode, there is no effect of excess noise, and the large full well capacity and high dynamic range are ideal for bright light applications that have large intrascene dynamic range. The ImagEM X2 series provides a low read noise non-EM mode that can be an ideal choice for such applications.

## Photon Imaging Mode (Patented)

This is a unique technology to improve image quality at very low light level to overcome the limitation of excess noise factor from the electron multiplying process. This mode is most useful for signal levels at which maximum EM gain has no apparent signal or very little signal. The mode preserves quantitative linear signal output and also improves spatial resolution at very low light levels.

#### ■ Sample of photon imaging mode

Fluorescence beads imaged with reduced excitation light intensity.



(Exposure time: 30.5 ms, EM gain: 1200×)

## On-board Image Processing

The following real time processing functions are available.

- Background subtraction  
Effective for reducing fluorescence in image backgrounds.
- Shading correction  
This feature corrects the shading or uneven illumination in microscope images or other illumination systems.
- Recursive filter  
This feature provides random noise elimination in an image by weighted time based averaging.
- Frame averaging  
This feature provides noise elimination in an image by simple frame averaging and less “afterimage” effect than the recursive filter.
- Spot noise reducer  
This image processing function operates on random spots of intensity by comparing incoming images and eliminating signals that meet the criteria for noise in one image but not in others. This processing eliminates noise elements like cosmic rays.

# Specifications

Type number	C9100-23B (ImagEM X2 EM-CCD camera)		C9100-24B (ImagEM X2-1K EM-CCD camera)	
Camera head type	Hermetic vacuum-sealed chamber air/water-cooled head *1			
Window	Anti-reflection (AR) coatings on both sides, single window			
AR mask	Yes	No		
Imaging device	Electron Multiplying Back-Thinned Frame Transfer CCD			
Effective number of pixels	512 (H) × 512 (V)		1024 (H) × 1024 (V)	
Pixel size	16 μm (H) × 16 μm (V)		13 μm (H) × 13 μm (V)	
Effective area	8.19 mm (H) × 8.19 mm (V)		13.3 mm (H) × 13.3 mm (V)	
Pixel clock rate	EM-CCD readout	22 MHz, 11 MHz, 0.6875 MHz		
	Normal-CCD readout	0.6875 MHz		
EM (electron multiplying) gain (typ.) *2	1×, 4× to 1200×		1×, 10× to 1200×	
Ultra-low light detection	Photon Imaging mode (1, 2, 3)			
Fastest readout speed	70.4 frames/s to 1076 frames/s		18.5 frames/s to 314 frames/s *3	
Readout noise (rms) (typ.)	EM-CCD readout	EM gain 4× (C9100-23B)	36 electrons (at 22 MHz)	
		10× (C9100-24B)	25 electrons (at 11 MHz)	
		EM gain 1200×	8 electrons (at 0.6875 MHz)	
	Normal CCD readout	1 electron max.		
Full well capacity (typ.)	EM-CCD mode	370 000 electrons	400 000 electrons	
	Normal-CCD mode	140 000 electrons	50 000 electrons	
Analog gain *4	EM-CCD readout	22 MHz	1×	
		11 MHz / 0.6875 MHz	0.5×, 1×	
	Normal CCD readout	1×, 2×, 3×, 4×, 5×		
Cooling method / temperature *5	Forced-air cooled	at temperature control (Ambient temperature: 0 °C to +30 °C)	-65 °C	
		at maximum cooling typ.	-80 °C (Ambient temperature: Stable at +20 °C)	
			-50 °C (at 22 MHz)	
	Water cooled *6	at temperature control (Water temperature: +20 °C)	-80 °C	-55 °C (11 MHz, 0.6875 MHz)
		at maximum cooling typ.	-100 °C (Water temperature: lower than +10 °C)	-60 °C (22 MHz, Ambient temperature: +20 °C)
				-65 °C (11 MHz, 0.6875 MHz, Ambient temperature: Stable at +20 °C)
Temperature stability (typ.)	0.01 °C			
Dark current (typ.) *7	Forced-air cooled	0.005 electron/pixel/s (-65 °C)	0.01 electron/pixel/s (-55 °C)	
	Water cooled	0.0005 electron/pixel/s (-80 °C)	0.001 electron/pixel/s (-70 °C)	
Clock induced charge (typ.)	0.0015 events/pixel/frame		0.01 events/pixel/frame	
Exposure time *8	Internal synchronous mode	13.9 ms to 1 s (22 MHz)	52.8 ms to 1 s (22 MHz)	
		27.2 ms to 2 h (11 MHz)	103.2 ms to 2 h (11 MHz)	
		421.5 ms to 2 h (0.6875 MHz)	1616.9 ms to 2 h (0.6875 MHz)	
	External trigger mode	10 μs to 1 s (22 MHz)		
	10 μs to 2 h (11 MHz / 0.6875 MHz / Normal-CCD readout)			
A/D converter	16 bit			
Interface	IEEE1394b			
Sub-array	Every 16 lines (horizontal, vertical) size, position can be set			
Binning	2×2, 4×4, 8×8, 16×16 *9		2×2, 4×4	
External trigger mode *10	Edge trigger, Level trigger, Start trigger, Synchronous readout trigger			
Trigger output *10	Exposure timing output, Programmable timing output (Delay and pulse length are variable.), Trigger ready output			
Image processing features (real-time) *11	Background subtraction, Shading correction, Recursive filter, Frame averaging, Spot noise reducer			
EM gain protection	EM warning mode, EM protection mode			
EM gain readjustment	Available			
Lens mount	C-mount			
Power requirements	AC 100 V to 240 V, 50 Hz / 60 Hz			
Power consumption	Approx. 140 VA			
Ambient operating temperature	0 °C to +40 °C			
Ambient operating humidity	70 % max. (with no condensation)			
Performance guaranteed temperature	0 °C to +30 °C			
Ambient storage temperature	-10 °C to +50 °C			
Ambient storage humidity	70 % max. (with no condensation)			

\*1 Hermetic vacuum-sealed chamber air/water-cooled head maintains a high degree of vacuum, 10<sup>-8</sup> Torr, without re-evacuation.

\*2 Even with electron multiplying gain maximum, dark signal is kept at a low level during low light imaging.

\*3 At 4×4 binning and 64×16 Sub-array

\*4 Linearity is not assured when full well capacity is over 370 000 electrons and 400 000 electrons, because of CCD performance.

\*5 The cooling temperature may not reach to this temperature; it depends on the operation condition.

\*6 Water volume 0.5 liter/min.

\*7 Typical thermal charge value (not guaranteed).

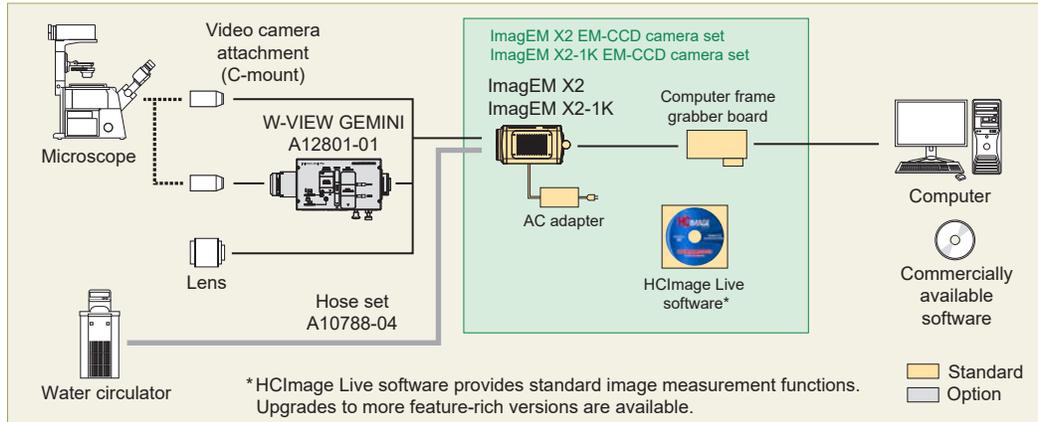
\*8 Image smearing may appear when the exposure time is short.

\*9 8×8 and 16×16 binning are available on special order. Please consult with our sales office.

\*10 C-MOS 3.3 V with reversible polarity.

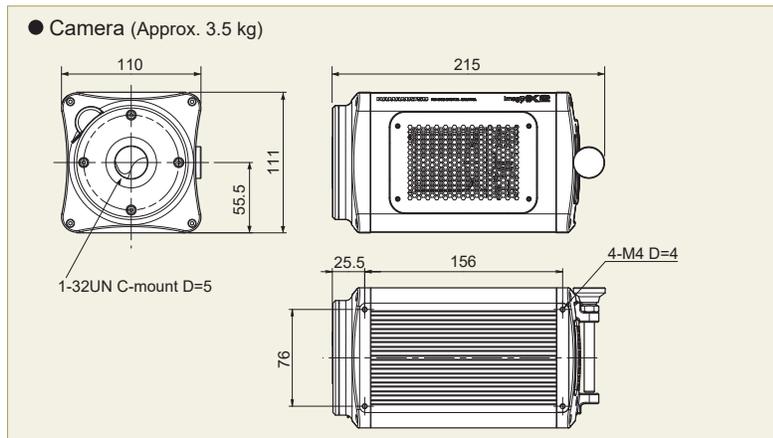
\*11 Recursive filter, frame averaging, and spot noise reducer cannot be used simultaneously.

## Configuration example



Please contact your local Hamamatsu representative or distributor regarding actual configuration.

## Dimensional outlines (Unit: mm)



## Options

- Binning option for C9100-23B: M10354-03
- External trigger cable SMA-BNC 5 m: A12106-05
- External trigger cable SMA-SMA 5 m: A12107-05
- Hose set without joint: A10788-04
- Base plate common for ImagEM X2 chassis: A12263-01
- W-VIEW GEMINI Image Splitting Optics: A12801-01\*



### \*W-VIEW GEMINI Image Splitting Optics (Option)

The W-VIEW GEMINI is an image splitting optics which provides one pair of dual wavelength images separated by a dichroic mirror onto a single camera. Simultaneous image acquisition of dual wavelength images allows you high speed ratio metric imaging and other multiple fluorescence applications.

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